



Is Now Part of



**ON Semiconductor®**

To learn more about ON Semiconductor, please visit our website at  
[www.onsemi.com](http://www.onsemi.com)

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marking.pdf](http://www.onsemi.com/site/pdf/Patent-Marking.pdf). ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.



# FMS6406 Precision S-Video Filter with Summed Composite Output, Sound Trap, and Group Delay Compensation

## Features

- 7.6MHz 5th-order Y,C filters with composite summer
- 14dB notch at 4.425MHz to 4.6MHz for sound trap capable of handling stereo
- 50dB stopband attenuation at 27MHz on Y, C, and CV outputs
- Better than 0.5dB flatness to 4.2MHz on Y, C, and CV outputs
- Equalizer and notch filter for driving RF modulator with group delay of -180ns
- No external frequency selection components or clocks
- < 5ns group delay on Y, C, and CV outputs
- AC coupled inputs
- AC or DC coupled outputs
- Capable of PAL frequency for Y, C, CV
- Continuous Time Low Pass Filters
- <1.4% differential gain with 0.7° differential phase on Y, C, and CV channels
- Integrated DC restore circuitry with low tilt

## Applications

- Cable set-top boxes
- Satellite set-top boxes
- DVD players

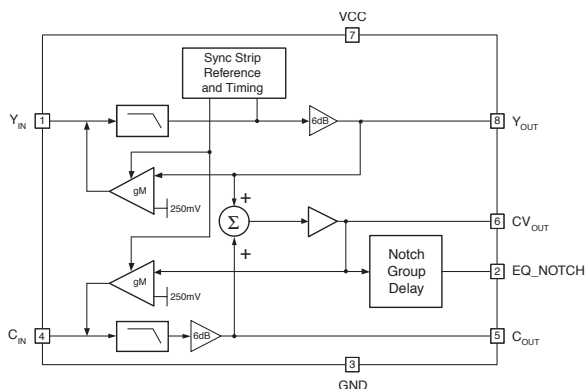
## Description

The FMS6406 is a dual Y/C 5th-order Butterworth lowpass video filter optimized for minimum overshoot and flat group delay. The device also contains a summing circuit to generate filtered composite video, an audio trap and group delay compensation circuit. The audio trap removes video information in the spectral location of the subsequent RF audio carrier. The group delay circuit predistorts the signal to compensate for the inherent receiver IF filter's group delay distortion.

In a typical application, the Y and C input signals from DACs are AC-coupled into the filters. Both channels have DC-restore circuitry to clamp the DC-input levels during video sync. The Y and C channels use separate feedback clamps. The clamp pulse is derived from the Y channel.

All outputs are capable of driving  $2V_{pp}$ , AC or DC-coupled, into either a single or dual video load. A single video load consists of a series  $75\Omega$  impedance matching resistor connected to a terminated  $75\Omega$  line, this presents a total of  $150\Omega$  of loading to the part. A dual load would be two of these in parallel which would present a total of  $75\Omega$  to the part. The gain of the Y, C and CV signals is 6dB with  $1V_{pp}$  input levels. All video channels are clamped during sync to establish the appropriate output voltage reference levels.

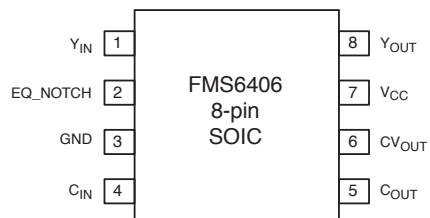
## Block Diagram



## Ordering Information

Part Number	Package	Pb-Free	Operating Temp Range	Packaging Method
FMS6406CS	SOIC-8	Yes	0°C to +70°C	Tube
FMS6406CSX	SOIC-8	Yes	0°C to +70°C	Tape and Reel

### FMS6406 Pin Configuration



### Pin Assignments

Pin#	Pin	Type	Description
1	Y <sub>IN</sub>	Input	Luminance (Luma) Input: In a typical system, this pin is connected to the Luma or composite video output pin from the external video encoder.
2	EQ_NOTCH	Output	Composite video output to RF modulator/driver.
3	GND	Input	Ground
4	C <sub>IN</sub>	Input	Chrominance (Chroma) Input: In a typical system, this pin is connected to the Chroma output pin from the external video encoder.
5	C <sub>OUT</sub>	Output	Filtered Chrominance Video Output from the C <sub>IN</sub> channel.
6	CV <sub>OUT</sub>	Output	Composite Video Output: This pin is the sum of Y <sub>OUT</sub> and C <sub>OUT</sub> .
7	V <sub>CC</sub>	Input	+5V supply.
8	Y <sub>OUT</sub>	Output	Filtered Luminance Video Output from the Y <sub>IN</sub> channel.

## Absolute Maximum Ratings

The “Absolute Maximum Ratings” are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The “Recommended Operating Conditions” table defines the conditions for actual device operation.

Parameter	Min.	Max.	Unit
$V_{CC}$	-0.3	6	V
Analog and Digital I/O	-0.3	$V_{CC} + 0.3$	V
Output Channel - Any One Channel (Do Not Exceed)		100	mA

### Notes:

Functional operation under any of these conditions is NOT implied. Performance and reliability are guaranteed only if operating conditions are not exceeded.

## Reliability Information

Parameter	Min.	Typ.	Max.	Unit
Junction Temperature			150	°C
Storage Temperature Range	-65		+150	°C
Lead Temperature (Soldering, 10s)			300	°C
Thermal Resistance ( $\theta_{JA}$ ), JEDEC Standard Multi-layer Test Boards, Still Air		115		°C/W

## Recommended Operating Conditions

Parameter	Min	Typ	Max	Unit
Operating Temperature Range	0		70	°C
$V_{CC}$ Range	+4.75	+5.0	+5.25	V
GND		0		V

## Electrical Characteristics

$T_C = 25^\circ\text{C}$ ,  $V_i = 1V_{pp}$ ,  $V_{CC} = 5V$ , all inputs AC-coupled with  $0.1\mu\text{F}$ , all outputs are AC-coupled with  $220\mu\text{F}$  into  $150\Omega$ , referenced to  $400\text{kHz}$ ; unless otherwise noted.

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$I_{CC}$	Supply Current <sup>1</sup>	$V_{CC}$ no load	50	80	110	mA
$AV_{YCCV}$	Low Frequency Gain ( $Y_{OUT}$ , $C_{OUT}$ , $CV_{OUT}$ ) <sup>1</sup>	at $400\text{kHz}$	5.8	6.0	6.2	dB
$AV_{EQ}$	Low Frequency Gain (EQ_NOTCH) <sup>1</sup>	at $400\text{kHz}$	5.7	6.0	6.4	dB
$C_{sync}$	$C_{OUT}$ Output Level (during Sync) <sup>1</sup>	Sync present on $Y_{IN}$ (after 6dB gain)	1.0	1.1	1.3	V
$Y_{sync}$	$Y_{OUT}$ Output Level (during Sync) <sup>1</sup>	Sync present on $Y_{IN}$ (after 6dB gain)		0.35	0.5	V
$CV_{sync}$	$CV_{OUT}$ Output Level (during Sync) <sup>1</sup>	Sync present on $Y_{IN}$ (after 6dB gain)		0.35	0.5	V
$EQ_{sync}$	EQ_NOTCH Output Level (during Sync) <sup>1</sup>	Sync present on $Y_{IN}$ (after 6dB gain)		0.35	0.5	V
$T_{CLAMP}$	Clamp Response Time (Y Channel)	Settled to within $10\text{mV}$		5		ms
$f_{FLAT}$	Gain Flatness to $4.2\text{MHz}^2$ ( $Y_{OUT}$ , $C_{OUT}$ , $CV_{OUT}$ )		-0.5	0	0.5	dB
$f_C$	-3dB Bandwidth <sup>1</sup>	Y, C, CV Channels	6.7	7.6		MHz
$f_{SB}$	Stopband Attenuation <sup>1</sup> ( $Y_{OUT}$ , $C_{OUT}$ , $CV_{OUT}$ )	at $27\text{MHz}$	40	50		dB
$V_i$	Input Signal Dynamic Range	All Channels/AC coupled		1.4		$V_{pp}$
$I_{SC}$	Output Short Circuit Current <sup>4</sup> (Any One Channel)	Y, C, CV, EQ_NOTCH to GND		85		mA
dG	Differential Gain <sup>2</sup>	Y, C, CV		1.4	3	%
d $\theta$	Differential Phase <sup>2</sup>	Y, C, CV		0.7	1.5	$^\circ$
THD	Output Distortion (All Channels)	$V_{OUT} = 1.8V_{pp}$ at $3.58\text{MHz}$		0.3		%
$X_{TALK}$	Crosstalk (Channel-to-Channel)	at $3.58\text{MHz}$		-50		dB
PSRR	PSRR (All Channels)	DC		50		dB
SNR	SNR Y, C Channel <sup>2</sup>	NTC-7 weighting $4.2\text{MHz}$ lowpass	70	75		dB
	SNR CV Channel <sup>2</sup>	NTC-7 weighting $4.2\text{MHz}$ lowpass	70	75		dB
	SNR EQ_NOTCH Channel <sup>2</sup>	NTC-7 weighting $4.2\text{MHz}$ lowpass	65	70		dB
$t_{pd}$	Propagation Delay (Y, C, CV)	at $400\text{kHz}$		112		ns
GD	Group Delay (Y, C, CV) <sup>2</sup>	at $3.58\text{MHz}$ (NTSC)	-5	0	5	ns
$t_{SKEW}$	Skew Between $Y_{OUT}$ and $C_{OUT}$ <sup>2</sup>	at $1\text{MHz}$	-2	0	2	ns
$t_{CLGCV}$	Chroma-Luma Gain $CV_{OUT}$ <sup>1</sup>	$f = 3.58\text{MHz}$ (ref to $Y_{IN}$ at $400\text{kHz}$ )	98	100	102	%
$t_{CLDCV}$	Chroma-Luma Delay $CV_{OUT}$ <sup>1</sup>	$f = 3.58\text{MHz}$ (ref to $Y_{IN}$ at $400\text{kHz}$ )	-10	0	10	ns
GD <sub>EQ</sub>	Group Delay EQ_NOTCH <sup>1</sup>	$f = 3.58\text{MHz}$ (ref to $Y_{IN}$ at $400\text{kHz}$ )	-195	-180	-165	ns
$t_{CLGEQ}$	Chroma-Luma Gain EQ_NOTCH <sup>1</sup>	$f = 3.58\text{MHz}$ (ref to $Y_{IN}$ at $400\text{kHz}$ )	95	100	105	%
$t_{CLDEQ}$	Chroma-Luma Delay EQ_NOTCH <sup>1</sup>	$f = 3.58\text{MHz}$ (ref to $Y_{IN}$ at $400\text{kHz}$ )	-195	-180	-165	ns
dG <sub>EQ</sub>	Differential Gain <sup>2</sup>	EQ_NOTCH Channel		0.3	1	%
d $\theta_{EQ}$	Differential Phase <sup>2</sup>	EQ_NOTCH Channel		0.3	0.75	%
MCF	Modulator Channel Flatness <sup>1,3</sup>	EQ_NOTCH from $400\text{kHz}$ to $3.75\text{MHz}$	-0.5	0	0.5	dB
$AV_{PK}$	Gain Peaking <sup>1</sup>	EQ_NOTCH from $>3.75\text{MHz}$ to $4.2\text{MHz}$	-0.5	0	0.5	dB
Atten1	Notch Attenuation 1 <sup>1</sup>	EQ_NOTCH at $4.425\text{MHz}$	14			dB
Atten2	Notch Attenuation 2 <sup>1</sup>	EQ_NOTCH at $4.5\text{MHz}$	20			dB
Atten3	Notch Attenuation 3 <sup>1</sup>	EQ_NOTCH at $4.6\text{MHz}$	14			dB
$t_{PASS}$	Passband Group Delay, EQ_NOTCH <sup>1</sup>	$f = 400\text{kHz}$ to $f = 3\text{MHz}$	-35		35	ns

### Notes:

- 100% tested at  $25^\circ\text{C}$ .
- Guaranteed by characterization.
- Tested down to  $400\text{kHz}$ , but guaranteed by design to  $200\text{kHz}$ .
- Sustained short circuit protection limited to 10 seconds.

### Typical Performance Characteristics

$T_c = 25^\circ\text{C}$ ,  $V_i = 1V_{pp}$ ,  $V_{CC} = 5V$ , all inputs AC-coupled with  $0.1\mu\text{F}$ , all outputs are AC-coupled with  $220\mu\text{F}$  into  $150\Omega$ , referenced to  $400\text{kHz}$ ; unless otherwise noted.

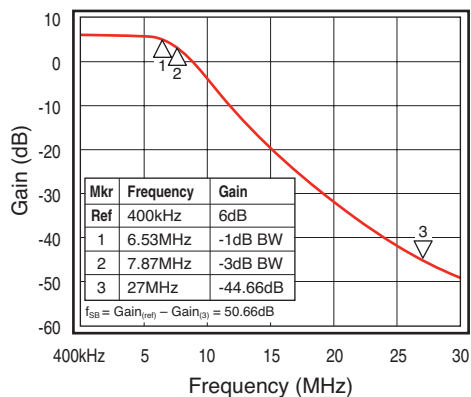


Figure 1. Frequency Response  $Y_{OUT}$

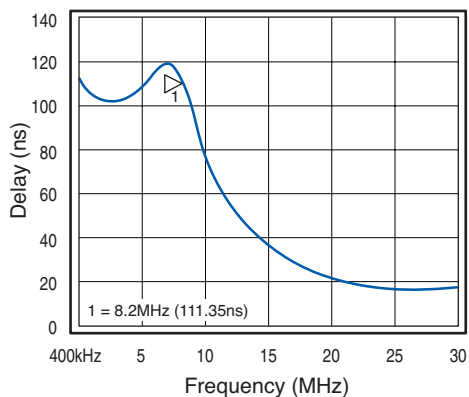


Figure 2. Group Delay vs. Frequency  $Y_{OUT}$

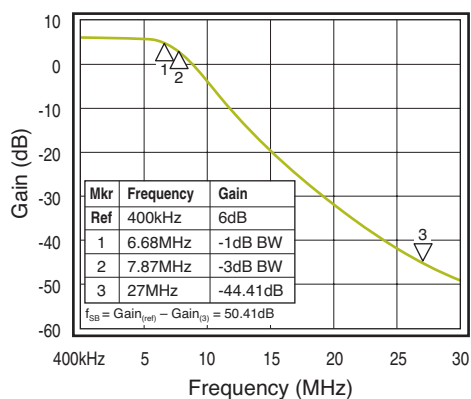


Figure 3. Frequency Response  $C_{OUT}$

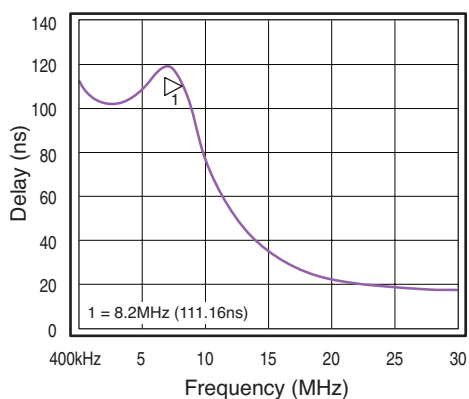


Figure 4. Group Delay vs. Frequency  $C_{OUT}$

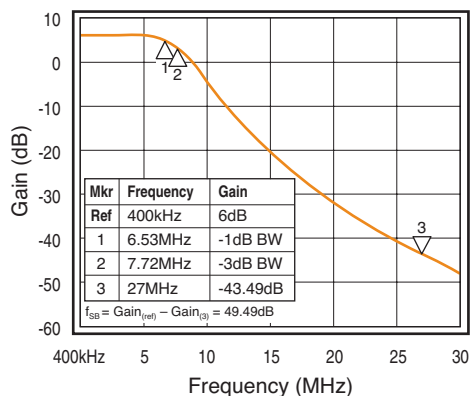


Figure 5. Frequency Response  $CV_{OUT}$

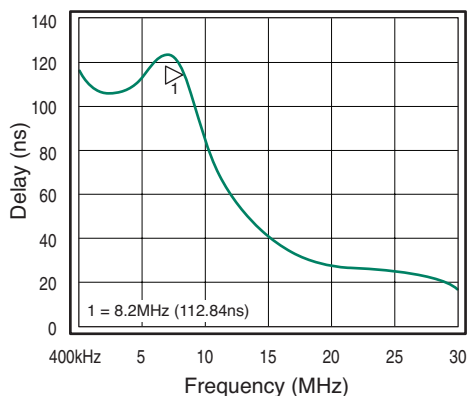


Figure 6. Group Delay vs. Frequency  $CV_{OUT}$

### Typical Performance Characteristics

$T_c = 25^\circ\text{C}$ ,  $V_i = 1V_{pp}$ ,  $V_{CC} = 5V$ ,  $HD/N\_SD = 0$ ,  $R_{SOURCE} = 37.5\Omega$ , all inputs AC-coupled with  $0.1\mu\text{F}$ , all outputs are AC-coupled with  $220\mu\text{F}$  into  $150\Omega$ , referenced to  $400\text{kHz}$ ; unless otherwise noted.

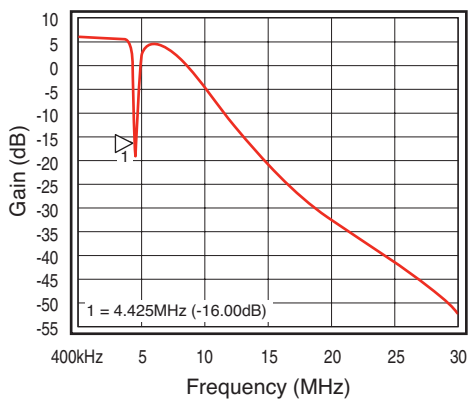


Figure 7. Modulator vs. Frequency Response

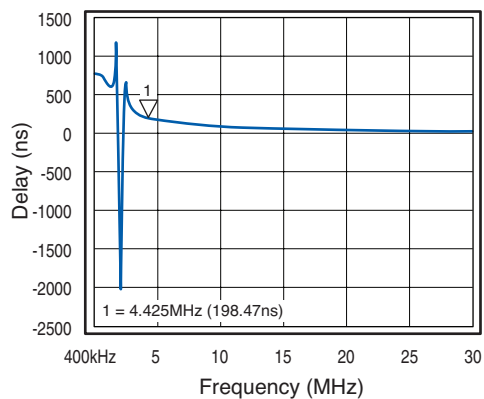


Figure 8. Delay Modulator Output

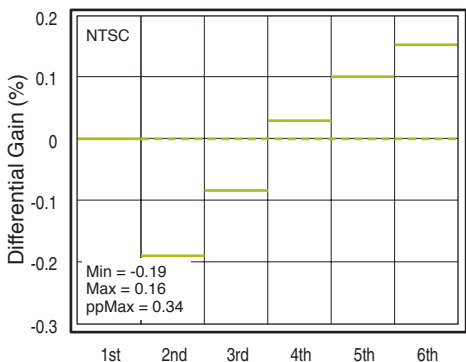


Figure 9. Differential Gain, MODOUT

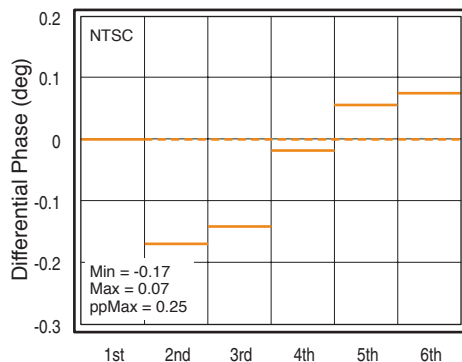


Figure 10. Differential Phase, MODOUT

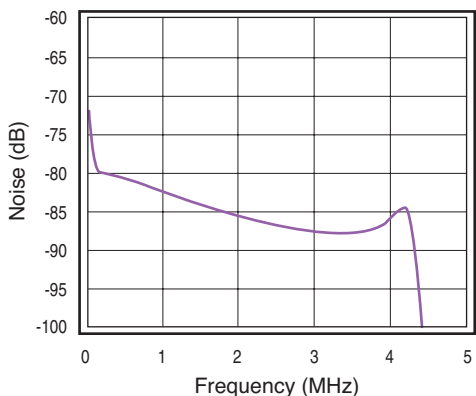


Figure 11. Noise vs. Freq. Modulator Channel

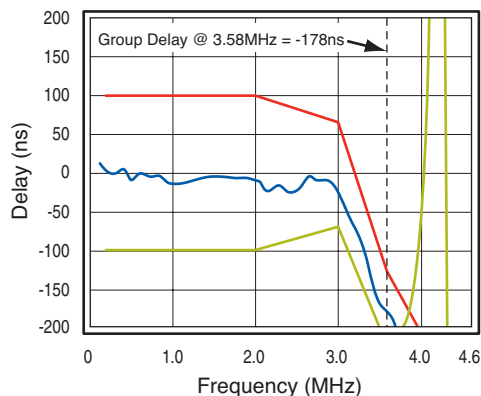


Figure 12. Group Delay vs. Frequency

### Typical Performance Characteristics

$T_c = 25^\circ\text{C}$ ,  $V_i = 1V_{pp}$ ,  $V_{CC} = 5V$ ,  $HD/N\_SD = 0$ ,  $R_{SOURCE} = 37.5\Omega$ , all inputs AC-coupled with  $0.1\mu\text{F}$ , all outputs are AC-coupled with  $220\mu\text{F}$  into  $150\Omega$ , referenced to  $400\text{kHz}$ ; unless otherwise noted.

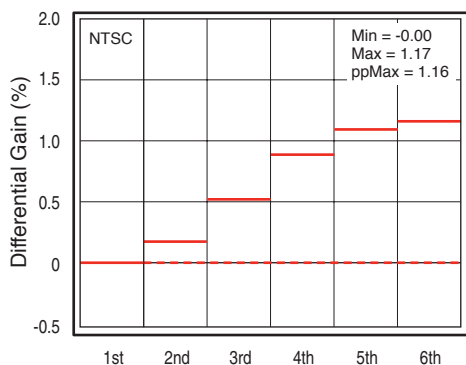


Figure 13. Differential Gain,  $V_{OUT}$

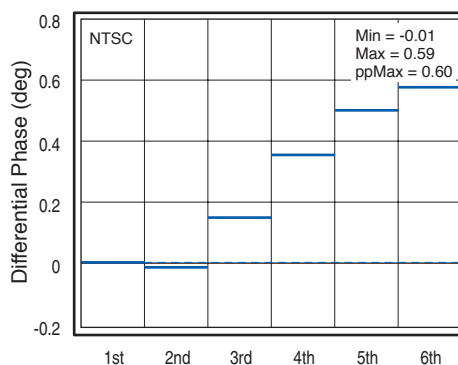


Figure 14. Differential Phase,  $V_{OUT}$

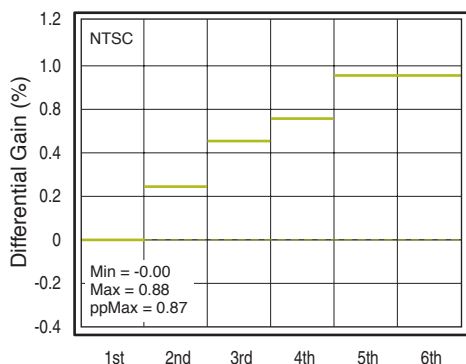


Figure 15. Differential Gain,  $C_{OUT}$

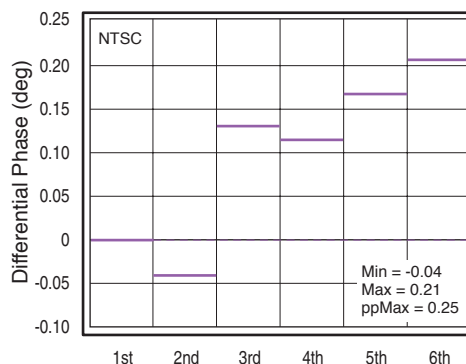


Figure 16. Differential Phase,  $C_{OUT}$

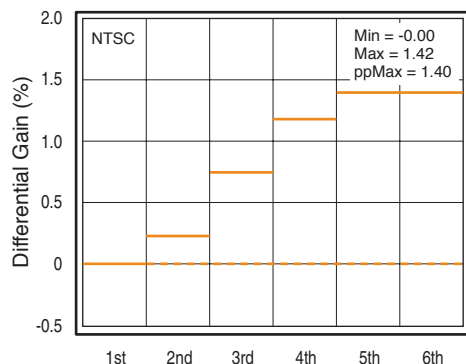


Figure 17. Differential Gain,  $CV_{OUT}$

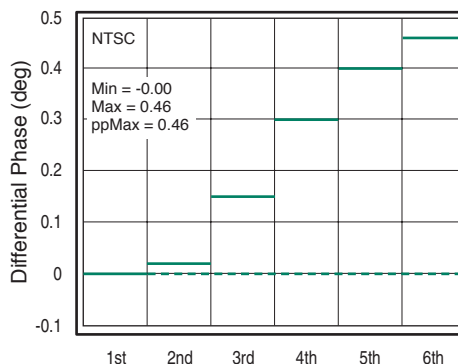


Figure 18. Differential Phase,  $CV_{OUT}$



### Typical Performance Characteristics

$T_c = 25^\circ\text{C}$ ,  $V_i = 1V_{pp}$ ,  $V_{CC} = 5V$ ,  $HD/N\_SD = 0$ ,  $R_{SOURCE} = 37.5\Omega$ , all inputs AC-coupled with  $0.1\mu\text{F}$ , all outputs are AC-coupled with  $220\mu\text{F}$  into  $150\Omega$ , referenced to  $400\text{kHz}$ ; unless otherwise noted.

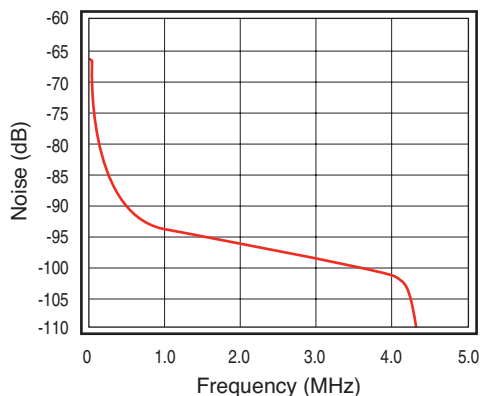


Figure 19. Noise vs. Frequency  $Y_{OUT}$

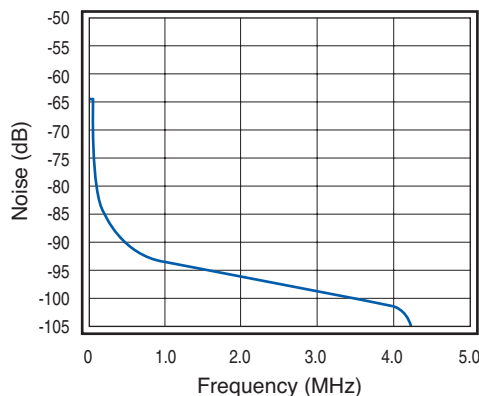


Figure 20. Noise vs. Frequency  $C_{OUT}$

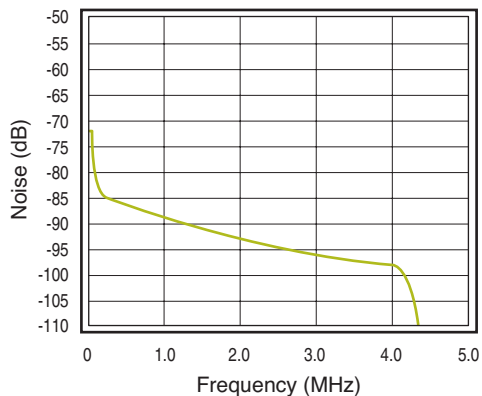
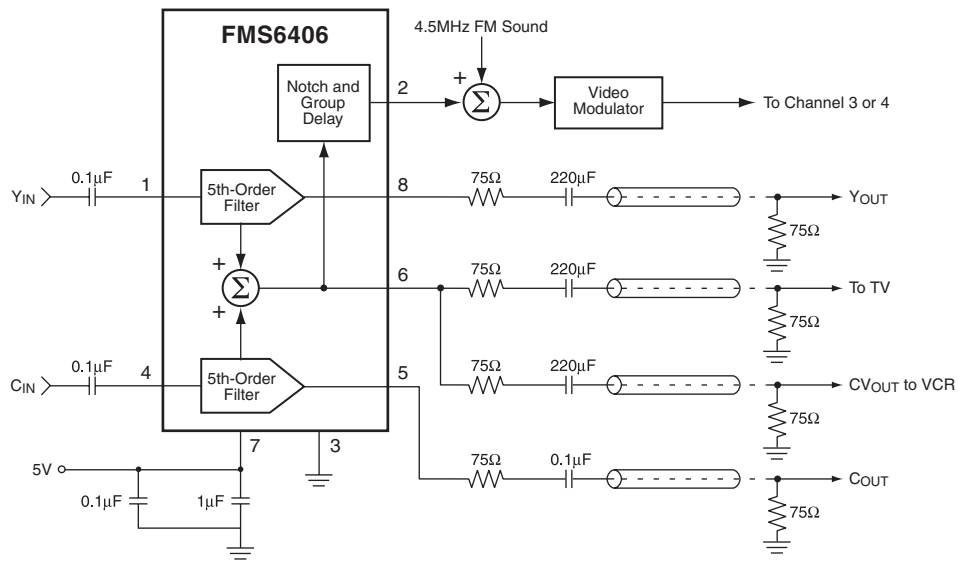
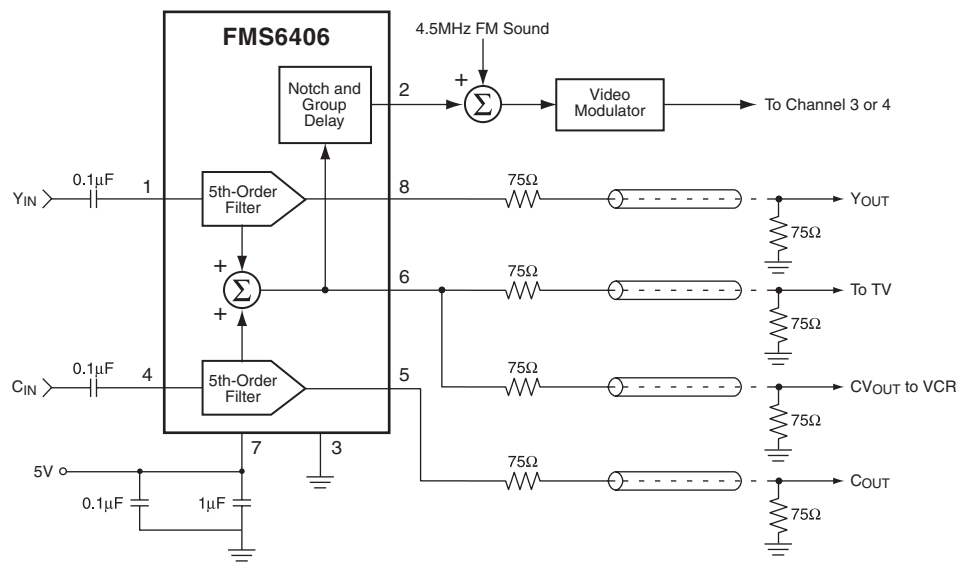


Figure 21. Noise vs. Frequency  $CV_{OUT}$

### Typical Application Diagrams



**Figure 22. AC-Coupled Application Diagram**



**Figure 23. DC-Coupled Application Diagram**

## Functional Description

### Introduction

This product is a two channel monolithic continuous time video filter designed for reconstructing the luminance and chrominance signals from an S-Video D/A source. Composite video output is generated by summing the Y and C outputs. The chip is designed to have AC coupled inputs and will work equally well with either AC or DC coupled outputs.

The reconstruction filters provide a 5th-order Butterworth response with group delay equalization. This provides a maximally flat response in terms of delay and amplitude. Each of the four outputs is capable of driving  $2V_{pp}$  into a  $75\Omega$  load.

All channels are clamped during the sync interval to set the appropriate minimum output DC level. With this operation the effective input time constant is greatly reduced, which allows for the use of small low cost coupling capacitors. The net effect is that the input will settle to 10mV in 5ms for any DC shifts present in the input video signal.

In most applications the input coupling capacitors are  $0.1\mu\text{F}$ . The Y and C inputs typically sink  $1\mu\text{A}$  of current during active video, which normally tilts a horizontal line by 2mV at the Y output. During sync, the clamp restores this leakage current by sourcing an average of  $20\mu\text{A}$  over the clamp interval. Any change in the coupling capacitor values will affect the amount of tilt per line. Any reduction in tilt will come with an increase in settling time.

### Luminance (Y) I/O

The typical luma input is driven by either a low impedance source of  $1V_{pp}$  or the output of a  $75\Omega$  terminated line driven by the output of a current DAC. In either case, the input must be capacitively coupled to allow the sync-detect and DC restore circuitry to operate properly.

All outputs are capable of driving  $2V_{pp}$ , AC or DC-coupled, into either a single or dual video load. A single video load consists of a series  $75\Omega$  impedance matching resistor connected to a terminated  $75\Omega$  line, this presents a total of  $150\Omega$  of loading to the part. A dual load would be two of these in parallel which would present a total of  $75\Omega$  to the part. The gain of the Y, C and CV signals is 6dB with  $1V_{pp}$  input levels. Even when two loads are present the driver will produce a full  $2V_{pp}$  signal at its output pin.

### Chrominance (C) I/O

The chrominance input can be driven in the same manner as the luminance input but is typically only a  $0.7V_{pp}$  signal.

Since the chrominance signal doesn't contain any DC content, the output signal can be AC coupled using as small as a  $0.1\mu\text{F}$  capacitor if DC-coupling is not desired.

### Composite Video (CV) Output

The composite video output driver is same as the other outputs. When driving a dual load either output will still function if the other output connection is inadvertently shorted providing these loads are AC-coupled.

### Equalizer/Notch (EQ\_NOTCH) Output

This output is designed to drive a  $600\Omega$  load to  $2V_{pp}$ , which will meet its primary intention of driving a modulator load.

### Layout Considerations

General layout and supply bypassing play major roles in high-frequency performance and thermal characteristics. The FMS6406DEMO is a 4-layer board with a full power and ground plane. Following this layout configuration will provide the optimum performance and thermal characteristics. For optimum results, follow the steps below as a basis for high frequency layout:

- Include  $1\mu\text{F}$  and  $0.1\mu\text{F}$  ceramic bypass capacitors
- Place the  $1\mu\text{F}$  capacitor within 0.75 inches of the power pin
- Place the  $0.1\mu\text{F}$  capacitor within 0.1 inches of the power pin
- For multi-layer boards, use a large ground plane to help dissipate heat
- For 2-layer boards, use a ground plane that extends beyond the device by at least 0.5"
- Minimize all trace lengths to reduce series inductances



## TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACE <sup>x</sup> ™	FAST®	ISOPLANAR™	PowerEdge™	SuperFET™
ActiveArray™	FAST <sub>r</sub> ™	LittleFET™	PowerSaver™	SuperSOT™-3
Bottomless™	FPS™	MICROCOUPLER™	PowerTrench®	SuperSOT™-6
Build it Now™	FRFET™	MicroFET™	QFET®	SuperSOT™-8
CoolFET™	GlobalOptoisolator™	MicroPak™	QS™	SyncFET™
CROSSVOLT™	GTO™	MICROWIRE™	QT Optoelectronics™	TCM™
DOME™	HiSeC™	MSX™	Quiet Series™	TinyLogic®
EcoSPARK™	I <sup>2</sup> C™	MSXPro™	RapidConfigure™	TINYOPTO™
E <sup>2</sup> CMOS™	i-Lo™	OCX™	RapidConnect™	TruTranslation™
EnSigna™	ImpliedDisconnect™	OCXPro™	μSerDes™	UHC™
FACT™	IntelliMAX™	OPTOLOGIC®	ScalarPump™	UniFET™
FACT Quiet Series™		OPTOPLANAR™	SILENT SWITCHER®	UltraFET®
Across the board. Around the world.™		PACMAN™	SMART START™	VCX™
The Power Franchise®		POP™	SPM™	Wire™
Programmable Active Droop™		Power247™	Stealth™	

## DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

## LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

## PRODUCT STATUS DEFINITIONS

### Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.

Rev. I19

ON Semiconductor and  are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marking.pdf](http://www.onsemi.com/site/pdf/Patent-Marking.pdf). ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

## PUBLICATION ORDERING INFORMATION

### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor  
19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA  
**Phone:** 303-675-2175 or 800-344-3860 Toll Free USA/Canada  
**Fax:** 303-675-2176 or 800-344-3867 Toll Free USA/Canada  
**Email:** [orderlit@onsemi.com](mailto:orderlit@onsemi.com)

**N. American Technical Support:** 800-282-9855 Toll Free  
USA/Canada  
**Europe, Middle East and Africa Technical Support:**  
Phone: 421 33 790 2910  
**Japan Customer Focus Center**  
Phone: 81-3-5817-1050

**ON Semiconductor Website:** [www.onsemi.com](http://www.onsemi.com)  
**Order Literature:** <http://www.onsemi.com/orderlit>  
For additional information, please contact your local  
Sales Representative